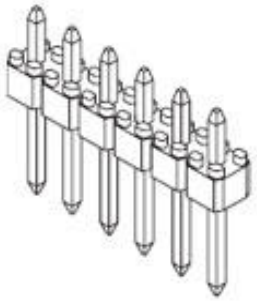
molex



Part Number : 901200960
Product Description : 2.54mm Pitch C-Grid III Header, Single Row, Vertical, 40 Circuits, 0.76µm Gold (Au) Selective Plating
Series Number : 90120
Status : Active
Product Category : PCB Headers and Receptacles

Documents & Resources

Drawings

901200960_sd.pdf

PK-90120-100-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

901190001-AS-000.pdf

PS-99020-0001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 33; 34; 63
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	90120
Description	2.54mm Pitch C-Grid III Header, Single Row, Vertical, 40 Circuits, 0.76µm Gold (Au) Selective Plating
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid III
UPC	800753716438

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	350V AC/DC

Physical

Breakaway	Yes
Circuits (Loaded)	40
Circuits (maximum)	40
Color - Resin	Black
Durability (mating cycles max)	500
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Material - Metal	Brass
Material - Plating Mating	Gold
Material - Plating Termination	Nickel
Material - Resin	Polyester
Net Weight	2.364/g
Number of Rows	1
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.90mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.762µm
Plating min - Termination	3.000µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	-55° to +125°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
C-Grid III Vertical Single Row PC Board Connectors	90147
C-Grid III Right-Angle Single Row PC Board Connectors	90148
C-Grid III Modular Single Row Crimp Housings	90123